Silicon N-Channel MOS FET

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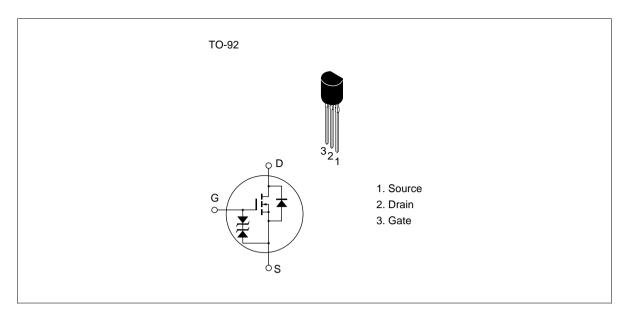
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device
 - Can be driven from 5 V source
- Suitable for motor drive, DC-DC converter, power switch and solenoid drive

Outline





Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

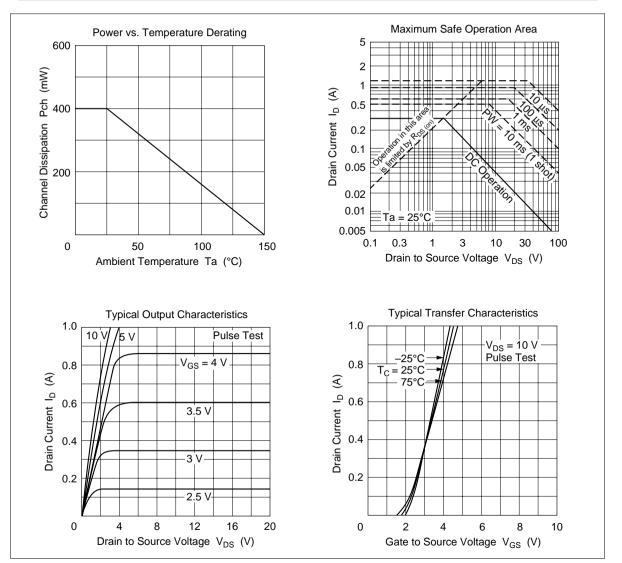
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	100	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	0.3	А
Drain peak current	I *1 D(pulse)	1.2	А
Body to drain diode reverse drain current	I _{DR}	0.3	А
Channel dissipation	Pch	400	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: 1. PW \leq 10 μ s, duty cycle \leq 1%

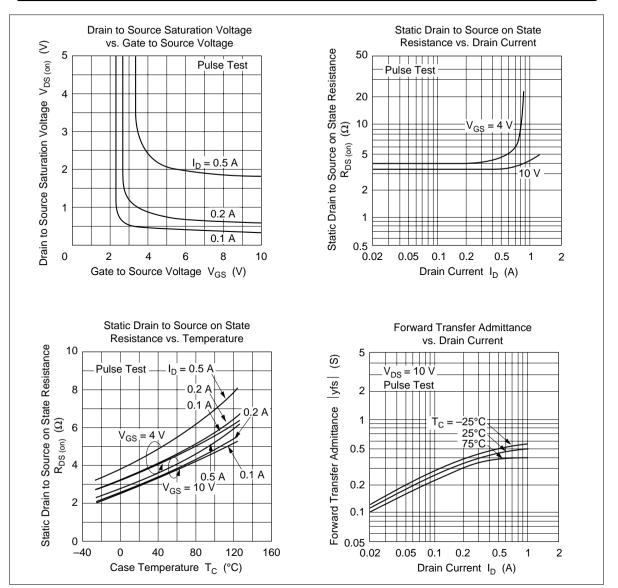
Electrical Characteristics ($Ta = 25^{\circ}C$)

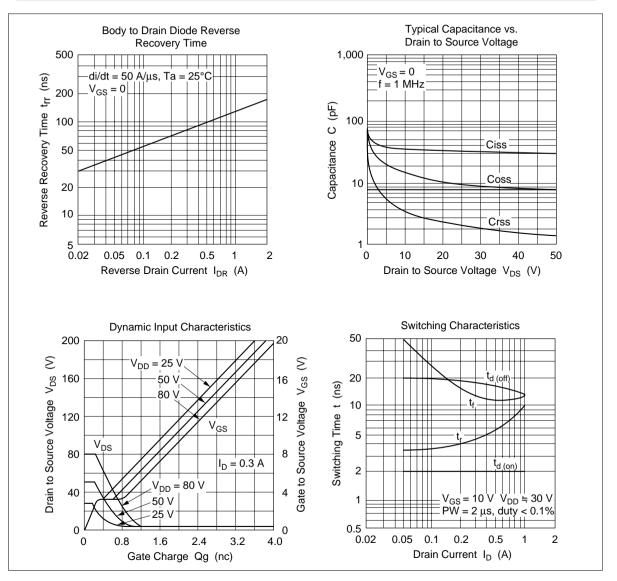
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	100	_		V	$I_{\rm D} = 10$ mA, $V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	—	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—	—	50	μA	$V_{\rm DS} = 80 \ V, \ V_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	—	2.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{\text{DS(on)}}$	_	3.5	4.5	Ω	$I_{\rm D} = 0.2 \text{ A}, \text{ V}_{\rm GS} = 10 \text{ V}^{*1}$
		_	4.0	6.5	Ω	$I_{\rm D} = 0.2 \text{ A}, V_{\rm GS} = 4 \text{ V}^{*1}$
Forward transfer admittance	yfs	0.22	0.35	_	S	$I_{\rm D} = 0.2$ A, $V_{\rm DS} = 10$ V *1
Input capacitance	Ciss	_	35		pF	$V_{\rm DS} = 10 \ V, \ V_{\rm GS} = 0,$
Output capacitance	Coss	_	14		pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	3.5	_	pF	
Turn-on delay time	t _{d(on)}	_	2		ns	$I_{\rm D} = 0.2$ A, $V_{\rm GS} = 10$ V,
Rise time	t,	_	4	_	ns	R _L = 150 Ω
Turn-off delay time	$t_{d(off)}$	_	17		ns	
Fall time	t _f	_	15		ns	
Body to drain diode forward voltage	V_{DF}	—	0.9	—	V	$I_{\rm F} = 0.3$ A, $V_{\rm GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	—	80	—	ns	$I_{F} = 0.3 \text{ A}, V_{GS} = 0,$ $di_{F}/dt = 50 \text{ A}/\mu \text{s}$
Note: 1 Pulse test						

Note: 1. Pulse test

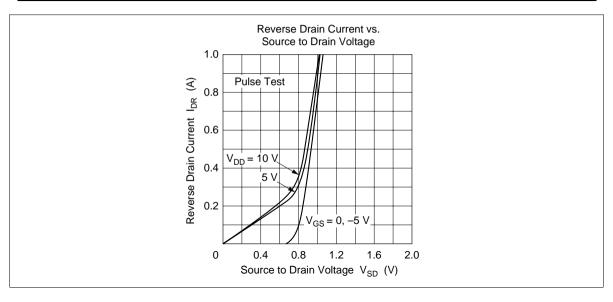


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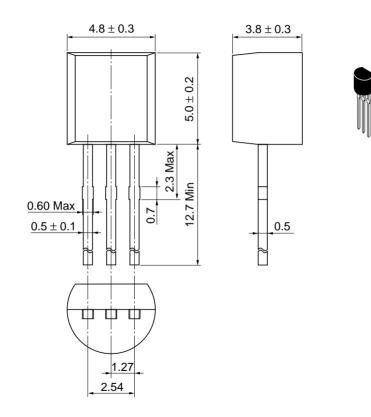




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Hitachi Code	TO-92 (1)
JEDEC	Conforms
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Weight (reference value)	0.25 g

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